PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6853600

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
XIAOXIA ZHANG	07/16/2021
JUN MA	07/20/2021
MORTEZA SOLTANI	07/20/2021
JING SUN	07/23/2021
IYAB ISSAM SAKHNINI	08/04/2021
TAO LUO	07/16/2021
HEMANT SAGGAR	08/02/2021

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17375610

CORRESPONDENCE DATA

Fax Number: (619)235-0398

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 619-238-1900

Email: Docketing@procopio.com, Patrick.Lemus@procopio.com
Correspondent Name: PROCOPIO CORY HARGREAVES & SAVITCH LLP.

Address Line 1: 525 B STREET, SUITE 2200
Address Line 4: SAN DIEGO, CALIFORNIA 92101

ATTORNEY DOCKET NUMBER:	129025-0920UT01/2104844
NAME OF SUBMITTER:	PATRICK LEMUS
SIGNATURE:	/Patrick Lemus/
DATE SIGNED:	08/06/2021

PATENT 506806781 REEL: 057114 FRAME: 0182

Total Attachments: 9 source=2104844 Assignment#page1.tif source=2104844 Assignment#page2.tif source=2104844 Assignment#page3.tif source=2104844 Assignment#page4.tif source=2104844 Assignment#page5.tif source=2104844 Assignment#page6.tif source=2104844 Assignment#page7.tif source=2104844 Assignment#page8.tif source=2104844 Assignment#page8.tif source=2104844 Assignment#page9.tif

ASSIGNMENT

WHEREAS, WE,

- 1. Xiaoxia ZHANG, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714.
- 2. Jun MA, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
- 3. Morteza SOLTANI, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
- 4. Jing SUN, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
- 5. Iyab Issam SAKHNINI, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
- 6. Tao LUO, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
- 7. Hemant SAGGAR, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to PHASE TRACKING REFERENCE SIGNAL INSERTION WITH HIGHER-RANK SINGLE-CARRIER WAVEFORM (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not

limited to U.S. Application No(s). 17/375,610 filed July 14, 2021, Qualcomm Reference Number 2104844, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument:

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT Qualcomm Reference Number, 2104844 Page 3 of 4

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

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escone an	25,888,175,5273, 54,839, 2011 City, State, Country	Date	Xiaosia ZHANG	
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	City, State, Country	Date	Jun MA	
Done at	, on, on			
	City, State, Country	Oate	Moneza SOLTANI	
Done at	, on			
	City, State, Country	Date	Jing SUN	***************************************
Done at	, On	Date	Iyab Issam SAKHNINI	
	City, State, Country	Date	Iyab Issam SAKHNINI	

Done at ______, on ______ City, State, Country Date Xiaoxía ZHANG Morteza SOLTANI Jing SUN Done at ______, on ____ Iyab Issam SAKHNINI

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whatsoever conflicting with these presents.

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	City, State, Country	Date	Xiaoxía ZHANG
Done at	City, State, Country	Date	Jun MA
Done at	San DespSA,USA on _ City, State, Country	07/20/2021 Date	Morteza SOLTANI
Done at	, on _ City, State, Country	Date	Jing SUN
Done at	, on	Date	Iyab Issam SAKHNINI

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	Uity, State, Country	Date	Jun MA	
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			Morteza SOLTANI	
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	City, State, Country	Date	Jing SUN	
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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

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	City, State, Country		Date	Xiaoxia ZHANG
Done at	City, State, Country	. on		
	City, State, Country	,	Date	Jun MA
Done at		, on		
	City, State, Country		Date	Morteza SOLTANI
Done at		, on		
	City, State, Country		Date	Jing SUN
Done at	5/KNO1840/ CA 68	on <u>4 AUG</u>	<u>2021</u>	
	City, State, Country		Date	Iyab Issam SAKHNINI

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done as Single Country On 10/10/2027 Coty, State, Country Date Tao I to

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Qualcomm Reference Number: 2104844

Page 4 of 4

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on			
City, State	e, Country	Date	Tao LUO	
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PATENT REEL: 057114 FRAME: 0192

RECORDED: 08/06/2021